# Shixian Liu

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Research Interests: Micro- and Nanoscale Heat Transfer

Personal Website: https://lyushisyan.github.io/



## **EDUCATION**

Bauman Moscow State Technical University, Ph.D. Candidate	2023.9 – Present
• Thermal Physics and Theoretical Heat Engineering (CSC International Cooperation Program)	
Bauman Moscow State Technical University, M.Sc.	2021.9 - 2023.7
• Nuclear Power and Thermal Physics (CSC International Cooperation Program)	
Moscow Power Engineering Institute, B.Sc.	2019.9 - 2021.7
• Nuclear Power and Thermal Physics (CSC Outstanding Undergraduate International Exchange Program)	
North China Electric Power University, B.Sc.	2017.9 - 2021.7
Nuclear Engineering and Nuclear Technology	

### **ACADEMIC ACHIEVEMENTS**

### **Journal Publications:**

- 1. <u>Liu S.</u>, Khvesuk V.I. Temperature Fluctuations in Quantum Dots: Insights from a T3/2 Heat Capacity Model. *Phys. Lett. A*, 2025, **534**, 130261. [Q2] [IF 2.3]
- 2. <u>Liu S.</u>, Yin F., Khvesuk V.I. Investigating Anisotropic Three-Phonon Interactions in Graphene's Thermal Conductivity Using Monte Carlo Method. *Int. J. Thermophys.*, 2025, **46**(2), 22. [Q2] [IF 2.5]
- 3. <u>Liu S.</u>, Barinov A.A., Yin F., Khvesuk V.I. Determination of Thermal Properties of Unsmooth Si Nanowires. *Chin. Phys. Lett.*, 2024, **41**(1), 016301. [Q1] [IF 3.5]
- 4. <u>Liu S.</u>, Yin F., Melikhov V.I., Melikhov O.I. Validation of the STEG code using experiments on Two-Phase flow across horizontal tube bundles. *Nucl. Eng. Des.*, 2022, **399**, 112048. [Q1] [IF 1.9]

#### **Program Patents:**

- 1. **Program for calculating the density of states of phonons in low-dimensional structures**Yin F. & Liu S. RU2025613785 Python 2025.02.17
- 2. **Program for Calculating Phonon Dispersion and Heat Capacity in Graphene and GNRs**<u>Liu S. & Barinov A.A.</u> RU2024661690 Matlab 2024.05.21
- 3. **Program for Solving the Dispersion Relations of Elastic Waves in Nanowires**Liu S. & Barinov A.A. RU2023615635 Matlab 2023.04.14

## **Academic Conferences:**

- 2024: VI-MMMSEC (Moscow, Russia); 8-WTT (Lanzhou, China); 17-MIF (Minsk, Belarus)
- 2023: 66-MIPT, V-MMMSEC (Moscow, Russia); 17-AVTIFG (Novosibirsk, Russia)
- 2022: RNKT-8 (Moscow, Russia)

## TECHNICAL SKILLS

#### **Computational Skills**

- Programming Languages: Matlab, Python, Fortran
- Simulation and Computational Tools: VASP, QE, GULP, phono3py, ShengBTE, etc.